



FEEDING EQUIPMENT SINGLE WAFER CHANGER

SKU: S3-0100

30.000,00 € excl. VAT



Categories: [Feeding equipment](#), [Modules](#)

BESCHREIBUNG

The Single Wafer Changer provides wafers individually for the Die Eject Unit.

The Wafer Changer is used to feed a wafer to be processed and to remove the processed wafer. An integrated magazine enables to provide automatically up to 25 wafers with a size of 4" to 8" alternately one after the other.

The wafers are fed in without opening the doors of the machine.

The Wafer Changer is equipped with a laser safety window, which allows the wafer system to be used in machines with laser applications.

MORE INFORMATION

Dimensions in mm (W x D x H)	394.5 x 350 x 439.5
Weight in kg	21,5
Max. wafer size in inch / mm	8 / 200
Voltage in V	24
Max. current in A	3
Communication interface	UNICAN

Häcker Automation GmbH
Inselsbergstraße 17
99880 Waltershausen / OT
Schwarzhausen

 **mikromontage.shop**

Contact us:
Consulting: +49 (0)36259 300 99
Support: +49 (0)36259 300 711
E-Mail: contact@haecker-automation.com

